



Layer Stack Up Detail for: MIXXEO.PCBDOC						
Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Material	Dielectric Constant	Dielectric Type
Top Solder Mask	(.GTS)		0.0102mm	Solder Resist	3.50	
Top	(.GTL)	0.0356mm				
GND	(.GP1)	0.0356mm	0.11mm	FR-4	4.80	Core
in1	(.G1)	0.0356mm	0.18mm	FR-4	4.80	PrePreg
in2	(.G2)	0.0356mm	0.71mm	FR-4	4.80	Core
PWR	(.GP2)	0.0356mm	0.18mm	FR-4	4.80	PrePreg
Bottom	(.GBL)	0.0356mm	0.11mm	FR-4	4.80	Core
Bottom Solder Mask	(.GBS)		0.0102mm	Solder Resist	3.50	